

V_{DRM}	= 2800	V	Phase Control Thyristor 5STP 16F2801
$I_{\text{T(AV)M}}$	= 1512	A	
$I_{\text{T(RMS)}}$	= 2375	A	
I_{TSM}	= 23.6×10^3	A	
$V_{\text{(T0)}}$	= 1.02	V	
r_{T}	= 0.265	mW	

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- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability

Blocking

Maximum rated values ¹⁾

Symbol	Conditions	5STP 16F2801	5STP 16F2601	5STP 16F2401
$V_{\text{DRM}}, V_{\text{RRM}}$	$f = 50 \text{ Hz}, t_p = 10 \text{ ms}$	2800 V	2600 V	2400 V
dV/dt_{crit}	Exp. to 1880 V, $T_{\text{vj}} = 125^\circ\text{C}$	1000 V/ μs		

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DRM}	$V_{\text{DRM}}, T_{\text{vj}} = 125^\circ\text{C}$			150	mA
Reverse leakage current	I_{RRM}	$V_{\text{RRM}}, T_{\text{vj}} = 125^\circ\text{C}$			150	mA

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_{M}		20	22	24	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				0.48	kg
Surface creepage distance	D_{S}		25			mm
Air strike distance	D_{a}		13			mm

1) Maximum rated values indicate limits beyond which damage to the device may occur

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On-state

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70^\circ\text{C}$			1512	A
RMS on-state current	$I_{T(RMS)}$				2375	A
Peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, $V_D = V_R = 0\text{ V}$			23.6×10^3	A
Limiting load integral	$I^2 t$				2.79×10^6	A^2s
Peak non-repetitive surge current	I_{TSM}	$t_p = 8.3\text{ ms}$, $T_{vj} = 125^\circ\text{C}$, $V_D = V_R = 0\text{ V}$			25.2×10^3	A
Limiting load integral	$I^2 t$				2.64×10^6	A^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 2000\text{ A}$, $T_{vj} = 125^\circ\text{C}$			1.55	V
Threshold voltage	$V_{(T0)}$	$I_T = 1900\text{ A} - 5800\text{ A}$, $T_{vj} = 125^\circ\text{C}$			1.02	V
Slope resistance	r_T				0.265	$\text{m}\Omega$
Holding current	I_H	$T_{vj} = 25^\circ\text{C}$		170		mA
		$T_{vj} = 125^\circ\text{C}$		90		mA
Latching current	I_L	$T_{vj} = 25^\circ\text{C}$		450		mA
		$T_{vj} = 125^\circ\text{C}$		350		mA

Switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	$T_{vj} = 125^\circ\text{C}$, $I_T = I_{T(AV)}$, Cont. $f = 50\text{ Hz}$			200	$\text{A}/\mu\text{s}$
Critical rate of rise of on-state current	di/dt_{crit}	$V_D \leq 1880\text{ V}$, $I_{FG} = 2\text{ A}$, $t_r = 0.3\text{ }\mu\text{s}$, Cont. $f = 1\text{ Hz}$			1000	$\text{A}/\mu\text{s}$
Circuit-commutated turn-off time	t_q	$T_{vj} = 125^\circ\text{C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -12.5\text{ A}/\mu\text{s}$, $V_D \leq 0.67 \cdot V_{DRM}$, $dv_D/dt = 50\text{ V}/\mu\text{s}$		200		μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	Q_{rr}	$T_{vj} = 125^\circ\text{C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -12.5\text{ A}/\mu\text{s}$		2600		μAs
Gate turn-on delay time	t_{gd}	$V_D = 0.4 \cdot V_{RM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.3\text{ }\mu\text{s}$, $T_{vj} = 25^\circ\text{C}$			2	μs

Triggering

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V_{FGM}				12	V
Peak forward gate current	I_{FGM}				10	A
Peak reverse gate voltage	V_{RGM}				10	V
Mean forward gate power	$P_{G(AV)}$				3	W

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate-trigger voltage	V_{GT}	$T_{vj} = -40\text{ °C}$	0.25		4	V
		$T_{vj} = 25\text{ °C}$			3	
		$T_{vj} = 125\text{ °C}$			2	
Gate-trigger current	I_{GT}	$T_{vj} = -40\text{ °C}$	10		500	mA
		$T_{vj} = 25\text{ °C}$			250	
		$T_{vj} = 125\text{ °C}$			150	

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}		-40		125	°C
Storage temperature range	T_{stg}		-40		125	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	$R_{th(j-c)}$	Double-side cooled $F_m = 20...24\text{ kN}$			16	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 20...24\text{ kN}$			25	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 20...24\text{ kN}$			45	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 20...24\text{ kN}$			4	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 20...24\text{ kN}$			8	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_{th i} (1 - e^{-t/\tau_i})$$

i	1	2	3	4
$R_{th i}(\text{K/kW})$	5.500	7.240	2.000	1.340
$\tau_i(\text{s})$	0.4653	0.1533	0.0375	0.0034

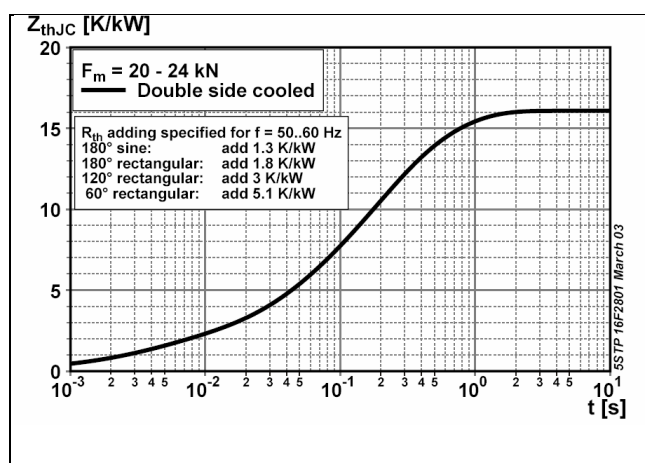


Fig. 1 Transient thermal impedance junction-to case.

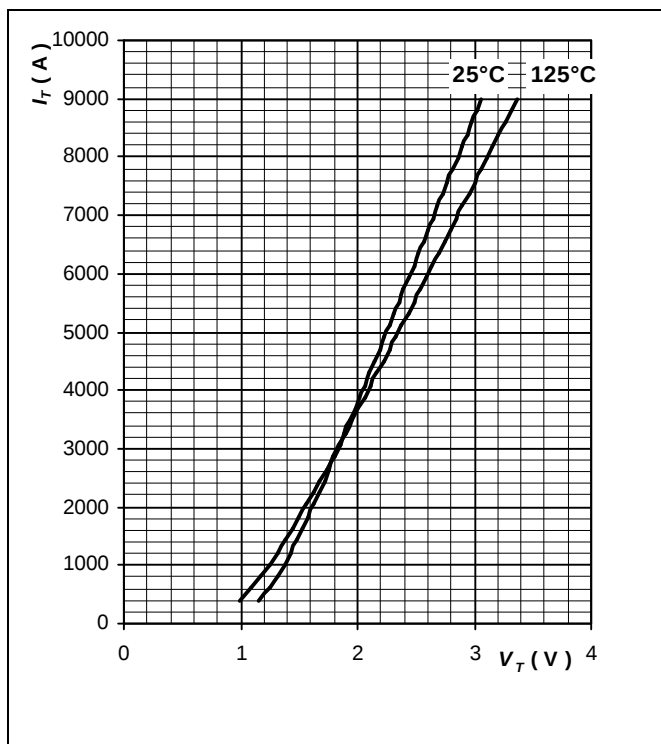


Fig. 2 Max. on-state voltage characteristics

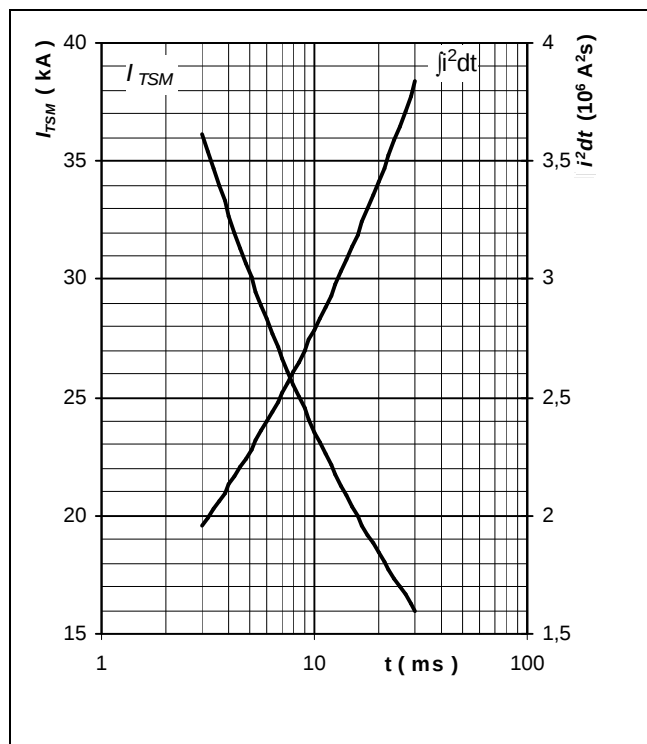
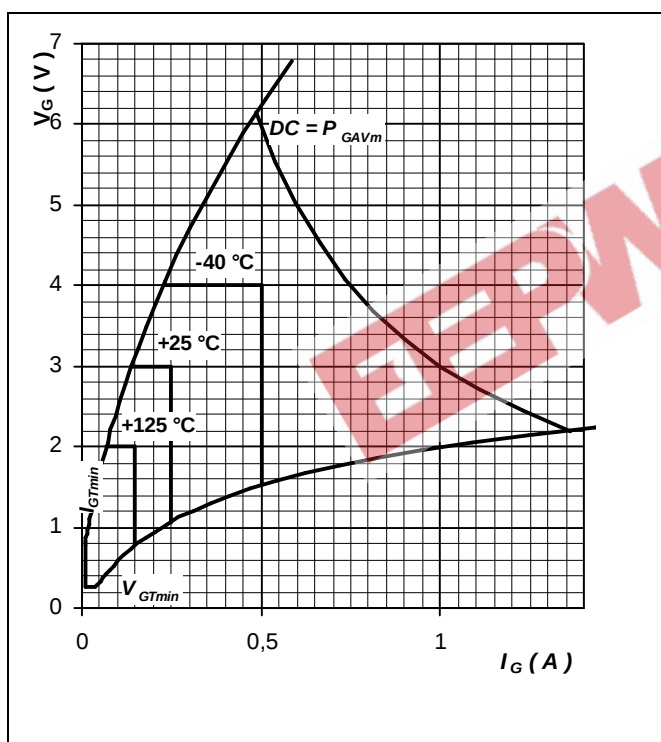
Fig. 3 Surge forward current vs. pulse length. Half sine wave, single pulse, $V_R = 0$ V

Fig. 4 Gate trigger characteristics

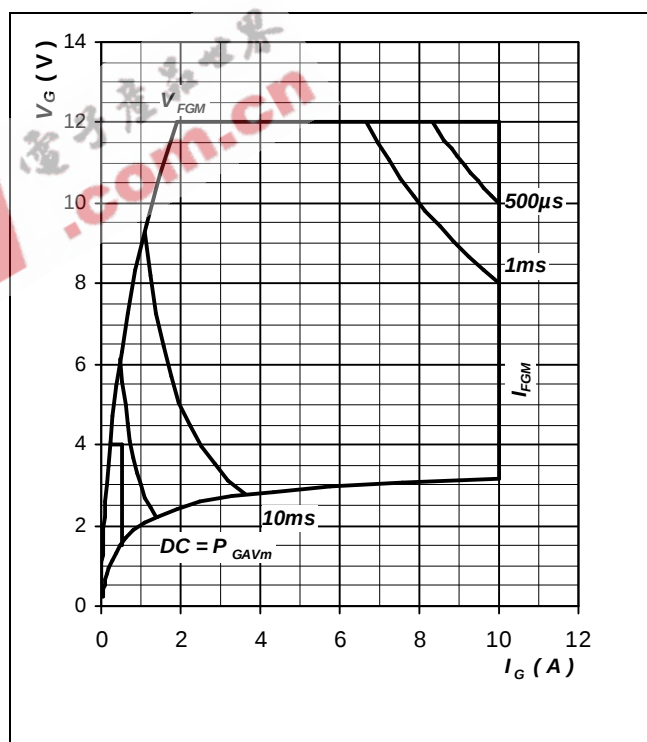


Fig. 5 Gate trigger characteristics

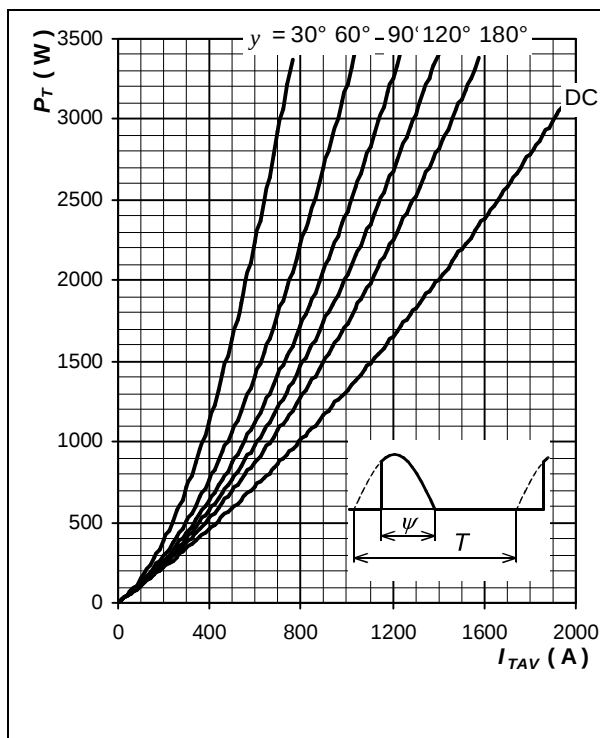


Fig. 6 Forward power loss vs. average forward current, sine waveform, $f = 50 \text{ Hz}$, $T = 1/f$

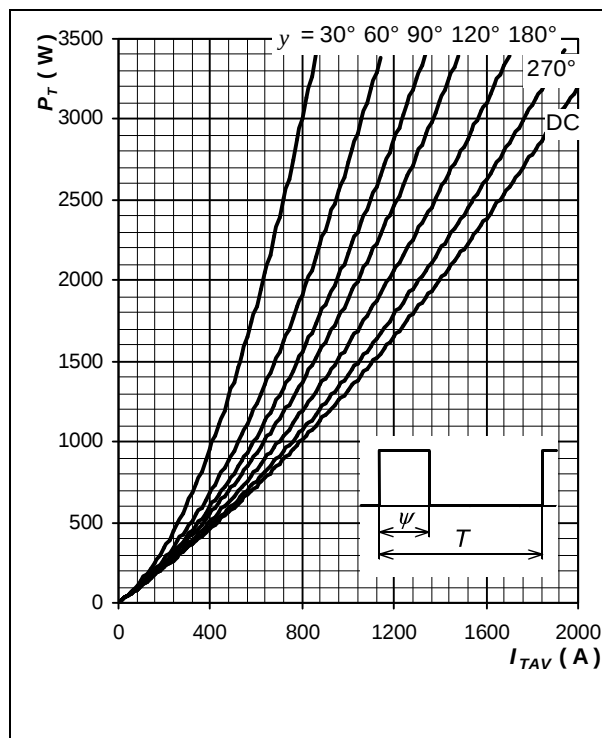


Fig. 7 Forward power loss vs. average forward current, square waveform, $f = 50 \text{ Hz}$, $T = 1/f$

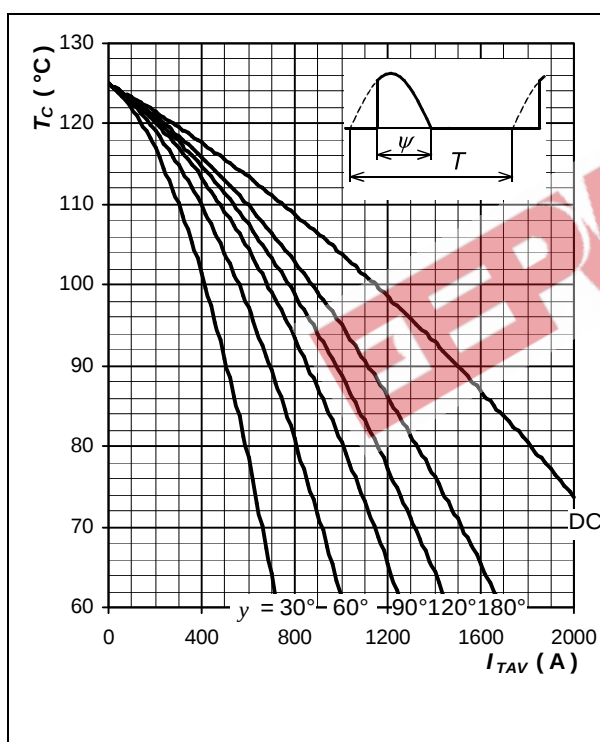


Fig. 8 Max. case temperature vs. average forward current, sine waveform, $f = 50 \text{ Hz}$, $T = 1/f$

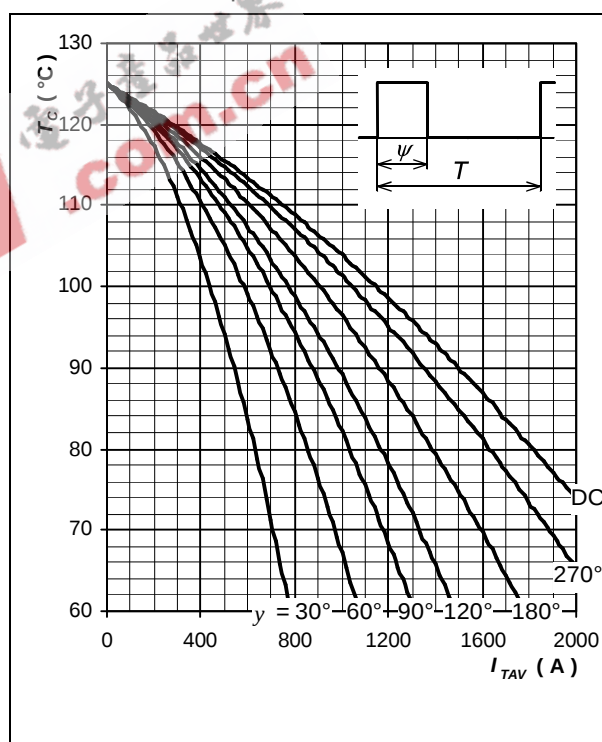


Fig. 9 Max. case temperature vs. average forward current, square waveform, $f = 50 \text{ Hz}$, $T = 1/f$

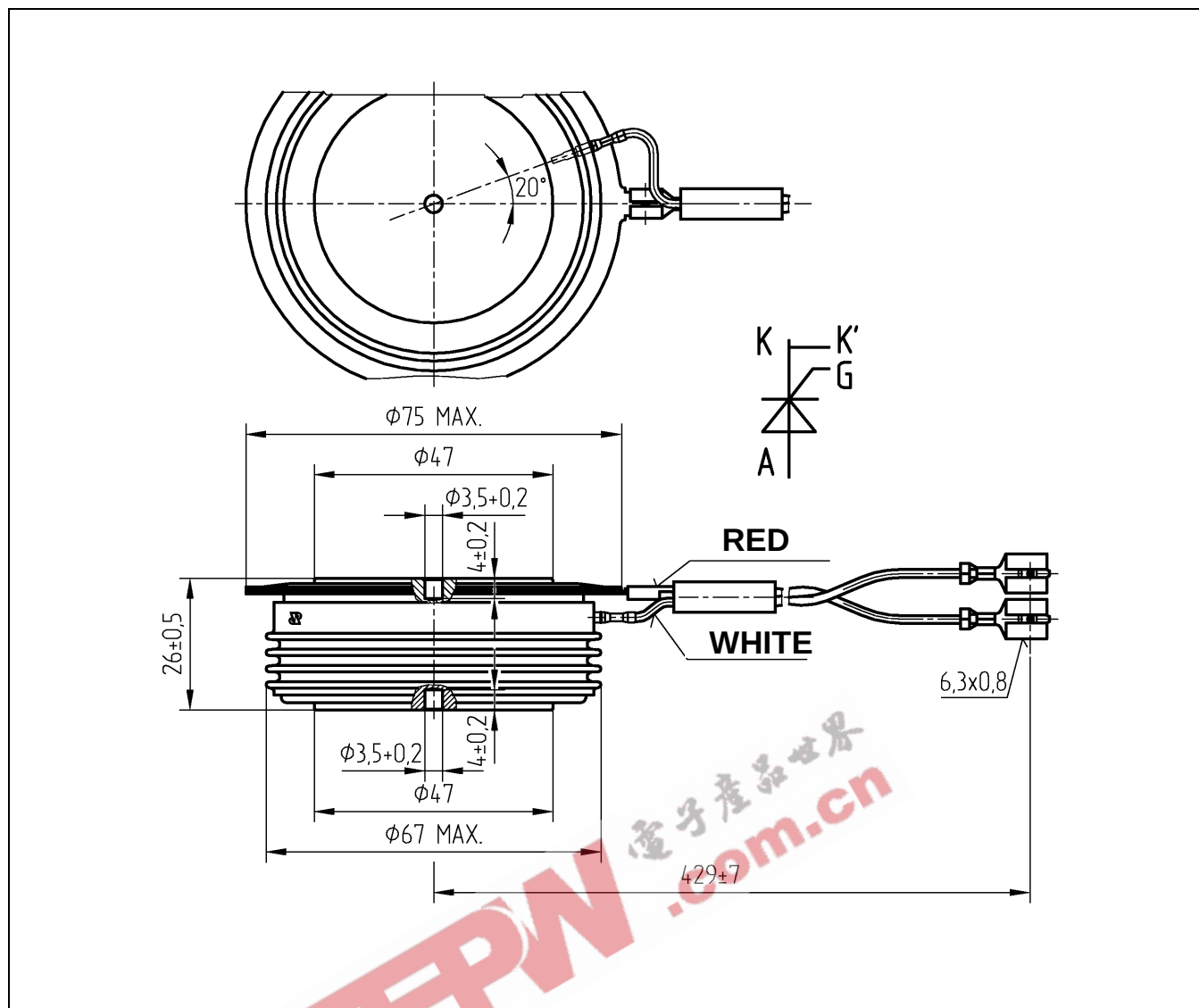


Fig. 10 Device Outline Drawing.

Related application notes:

Doc. Nr	Titel
5SYA2020	Design of RC-Snubber for Phase Control Applications
5SYA2034	Gate-drive Recommendations for PCT's
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
Please refer to http://www.abb.com/semiconductors for actual versions.	

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